

RELIABILITY REPORT FOR MAX6968AUE+ PLASTIC ENCAPSULATED DEVICES

November 9, 2010

MAXIM INTEGRATED PRODUCTS

120 SAN GABRIEL DR.

SUNNYVALE, CA 94086

Approved by	
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Conclusion

The MAX6968AUE+ successfully meets the quality and reliability standards required of all Maxim products. In addition, Maxim's continuous reliability monitoring program ensures that all outgoing product will continue to meet Maxim's quality and reliability standards.

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- I. Device Description
 - A. General

The MAX6968 serial-interfaced LED driver provides eight open-drain, constant-current sinking LED driver outputs rated at 5.5V. The MAX6968 operates from a 3V to 5.5V supply. The MAX6968 supply and the LEDs' supply or supplies may power up in any order. The constant-current outputs are programmed together to up to 55mA using a single external resistor. The MAX6968 operates with a 25Mb, industry-standard, 4-wire serial interface. The MAX6968 uses the industry-standard shift-register-plus-latch-type serial interface. The driver accepts data shifted into an 8-bit shift register using data input DIN and clock input CLK. Input data appears at the output DOUT eight clock cycles later to allow cascading of multiple MAX6968s. The latch-enable input LE loads the 8 bits of shift register data into an 8-bit output latch to set which LEDs are on and which are off. The output-enable input active-low OE gates all eight outputs on and off, and is fast enough to be used as a PWM input for LED intensity control. For applications requiring LED fault detection, refer to the MAX6977 data sheet that automatically detects open-circuit LEDs. For safety-related applications requiring a watchdog timer, refer to the MAX6978 data sheet that includes a fail-safe feature that blanks the display if the serial interface becomes inactive for more than 1s. The MAX6968 is one of a family of 12 shift-register-plus-latch-type LED drivers. The family includes 8-port and 16-port types, with 5.5V- or 36V-rated LED outputs, with and without open-circuit LED detection and watchdog. All versions operate from a 3V to 5.5V supply, and are specified over the -40°C to +125°C temperature range.



II. Manufacturing Information

B. Process:

8-Port, 5.5V Constant-Current LED Driver B8

Oregon

Philippines, Thailand

January 22, 2005

- C. Number of Device Transistors:
- D. Fabrication Location:

A. Description/Function:

- E. Assembly Location:
- F. Date of Initial Production:

III. Packaging Information

A. Package Type:	16-pin TSSOP
B. Lead Frame:	Copper
C. Lead Finish:	100% matte Tin
D. Die Attach:	Conductive
E. Bondwire:	Au (1 mil dia.)
F. Mold Material:	Epoxy with silica filler
G. Assembly Diagram:	#05-9000-1675
H. Flammability Rating:	Class UL94-V0
 Classification of Moisture Sensitivity per JEDEC standard J-STD-020-C 	Level 1
J. Single Layer Theta Ja:	47°C/W
K. Single Layer Theta Jc:	3°C/W
L. Multi Layer Theta Ja:	38.3°C/W
M. Multi Layer Theta Jc:	3°C/W

IV. Die Information

Α.	Dimensions:	80 X 76 mils
В.	Passivation:	$Si_3N_4/SiO_2\;$ (Silicon nitride/ Silicon dioxide)
C.	Interconnect:	Al/0.5%Cu with Ti/TiN Barrier
D.	Backside Metallization:	None
Ε.	Minimum Metal Width:	0.8 microns (as drawn)
F.	Minimum Metal Spacing:	0.8 microns (as drawn)
G.	Bondpad Dimensions:	5 mil. Sq.
Н.	Isolation Dielectric:	SiO ₂
I. [Die Separation Method:	Wafer Saw



V.	Quality	Assurance	Information
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A. Quality Assurance Contacts:	Don Lipps (Manager, Reliability Engineering) Bryan Preeshl (Vice President of QA)
B. Outgoing Inspection Level:	0.1% for all electrical parameters guaranteed by the Datasheet. 0.1% For all Visual Defects.
C. Observed Outgoing Defect Rate:	< 50 ppm
D. Sampling Plan:	Mil-Std-105D

VI. Reliability Evaluation

A. Accelerated Life Test

The results of the 135°C biased (static) life test are shown in Table 1. Using these results, the Failure Rate (A) is calculated as follows:

 $\lambda = \underbrace{1}_{\text{MTTF}} = \underbrace{1.83}_{192 \times 4340 \times 48 \times 2}$ (Chi square value for MTTF upper limit) (where 4340 = Temperature Acceleration factor assuming an activation energy of 0.8eV) $\lambda = 22.9 \times 10^{-9}$

λ = 22.9 F.I.T. (60% confidence level @ 25°C)

The following failure rate represents data collected from Maxim"s reliability monitor program. Maxim performs quarterly life test monitors on its processes. This data is published in the Reliability Report found at http://www.maxim-ic.com/qa/reliability/monitor. Cumulative monitor data for the B8 Process results in a FIT Rate of 0.06 @ 25C and 0.99 @ 55C (0.8 eV, 60% UCL)

B. E.S.D. and Latch-Up Testing (lot SZXAAQ001B, D/C 0452)

The DW84 die type has been found to have all pins able to withstand a HBM transient pulse of +/-2500V per Mil-Std 883 Method 3015.7. Latch-Up testing has shown that this device withstands a current of +/-250mA.



Table 1 Reliability Evaluation Test Results

MAX6968AUE+

TEST ITEM	TEST CONDITION	FAILURE IDENTIFICATION	SAMPLE SIZE	NUMBER OF FAILURES	COMMENTS
Static Life Test (Note	e 1) Ta = 135°C Biased Time = 192 hrs.	DC Parameters & functionality	48	0	SZXAAQ001B, DC 0453

Note 1: Life Test Data may represent plastic DIP qualification lots.